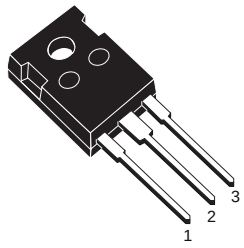
STGW20NB60K

N-CHANNEL 20A - 600V - TO-247
SHORT CIRCUIT PROOF PowerMESH™ IGBT

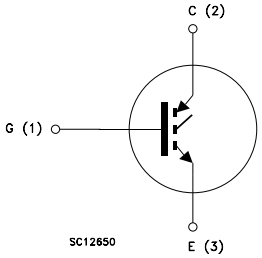
TYPE	V_{CES}	$V_{CE(sat)}$	I_C
STGW20NB60K	600 V	< 2.8 V	20 A

- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (V_{cesat})
- LOW ON-LOSSES
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- OFF LOSSES INCLUDE TAIL CURRENT
- VERY HIGH FREQUENCY OPERATION
- SHORT CIRCUIT RATED
- LATCH CURRENT FREE OPERATION



TO-247

INTERNAL SCHEMATIC DIAGRAM



DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix “K” identifies a family optimized for high frequency motor control applications with short circuit withstand capability.

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- U.P.S.
- WELDING EQUIPMENTS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage (V_{GS} = 0)	600	V
V_{ECR}	Emitter-Collector Voltage	20	V
V_{GE}	Gate-Emitter Voltage	±20	V
I_C	Collector Current (continuos) at T_C = 25°C	40	A
I_C	Collector Current (continuos) at T_C = 100°C	20	A
I_{CM} (▪)	Collector Current (pulsed)	80	A
Tsc	Short Circuit Withstand	10	µs
P_{TOT}	Total Dissipation at T_C = 25°C	150	W
	Derating Factor	1	W/°C
T_{stg}	Storage Temperature	–65 to 150	°C
T_j	Max. Operating Junction Temperature	150	°C

THERMAL DATA

Rthj-case	Thermal Resistance Junction-case Max	0.83	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5	°C/W
Rthc-h	Thermal Resistance Case-heatsink Typ	0.5	°C/W

ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{BR(CES)}$	Collectro-Emitter Breakdown Voltage	I_C = 250 µA, V_{GE} = 0	600			V
I_{CES}	Collector cut-off (V_{GE} = 0)	V_{CE} = Max Rating, T_C = 25 °C			10	µA
		V_{CE} = Max Rating, T_C = 125 °C			100	µA
I_{GES}	Gate-Emitter Leakage Current (V_{CE} = 0)	V_{GE} = ±20V , V_{CE} = 0			±100	nA

ON (1)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Threshold Voltage	V_{CE} = V_{GE}, I_C = 250µA	5		7	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V_{GE} = 15V, I_C = 20 A		2.3	2.8	V
		V_{GE} = 15V, I_C = 20 A, Tj =125°C		1.9		V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs}	Forward Transconductance	V_{CE} = 25 V , I_C =20 A		8		S
C_{ies}	Input Capacitance	V_{CE} = 25V, f = 1 MHz, V_{GE} = 0		1300		pF
C_{oes}	Output Capacitance			200		pF
C_{res}	Reverse Transfer Capacitance			30		pF
Q_g	Total Gate Charge	V_{CE} = 480V, I_C = 20 A, V_{GE} = 15V		90		nC
Q_{ge}	Gate-Emitter Charge			T.B.D.		nC
Q_{gc}	Gate-Collector Charge			T.B.D.		nC
tscw	Short Circuit Withstand Time	V_{ce} = 0.5 BVces , V_{GE} = 15 V, Tj = 125°C , R_G = 10 Ω	10			µs

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	V_{CC} = 480 V, I_C = 20 A		20		ns
t_r	Rise Time	R_G = 10Ω , V_{GE} = 15 V		70		ns
$(di/dt)_{on}$	Turn-on Current Slope	V_{CC}= 480 V, I_C = 20 A R_G=10Ω V_{GE} = 15 V,Tj = 125°C		350		A/µs
Eon	Turn-on Switching Losses			300		µJ

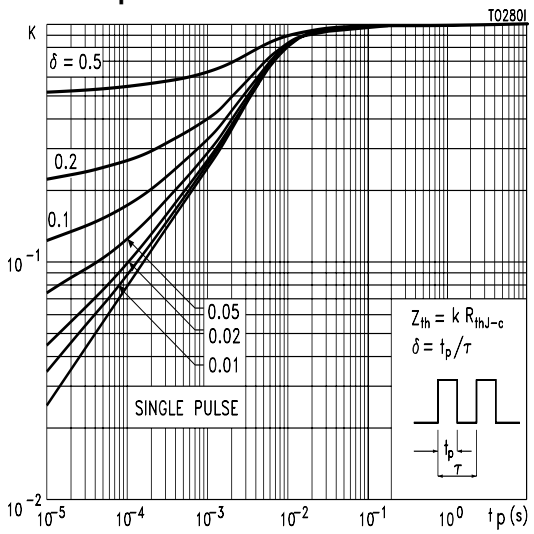
ELECTRICAL CHARACTERISTICS (CONTINUED)

SWITCHING OFF

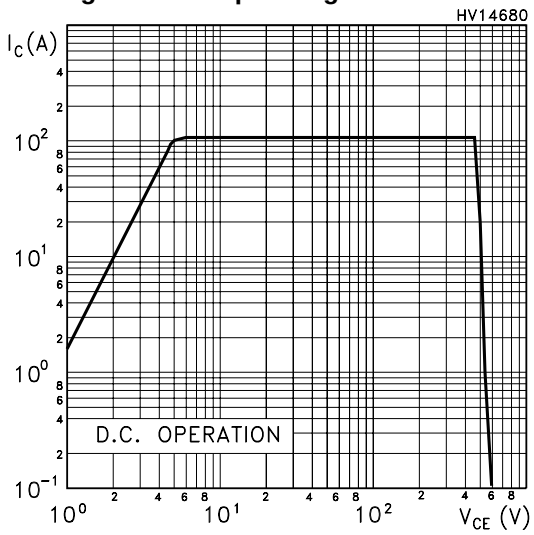
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_c	Cross-over Time	V_{cc} = 480 V, I_C = 20 A, R_{GE} = 10 Ω , V_{GE} = 15 V		120		ns
$t_r(V_{off})$	Off Voltage Rise Time			35		ns
$t_{d(off)}$	Delay Time			130		ns
t_f	Fall Time			80		ns
E_{off}(**)	Turn-off Switching Loss			0.45		mJ
E_{ts}	Total Switching Loss			0.6		mJ
t_c	Cross-over Time	V_{cc} = 480 V, I_C = 20 A, R_{GE} = 10 Ω , V_{GE} = 15 V Tj = 125 °C		190		ns
$t_r(V_{off})$	Off Voltage Rise Time			55		ns
$t_{d(off)}$	Delay Time			160		ns
t_f	Fall Time			150		ns
E_{off}(**)	Turn-off Switching Loss			0.75		mJ
E_{ts}	Total Switching Loss			1.05		mJ

Note: 1. Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
2. Pulse width limited by max. junction temperature.
(**)Losses include Also the Tail (Jedec Standardization)

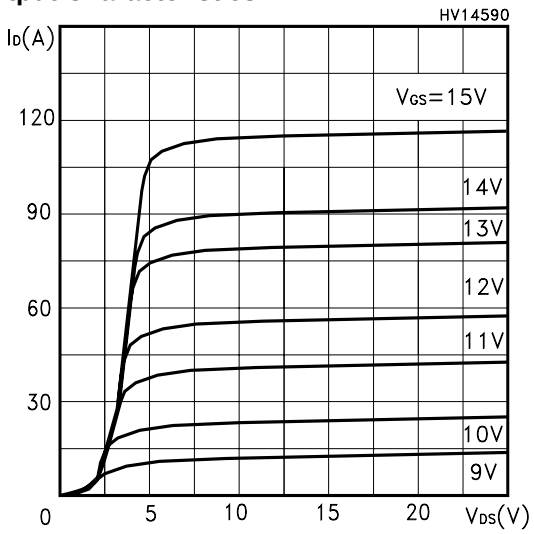
Thermal Impedance



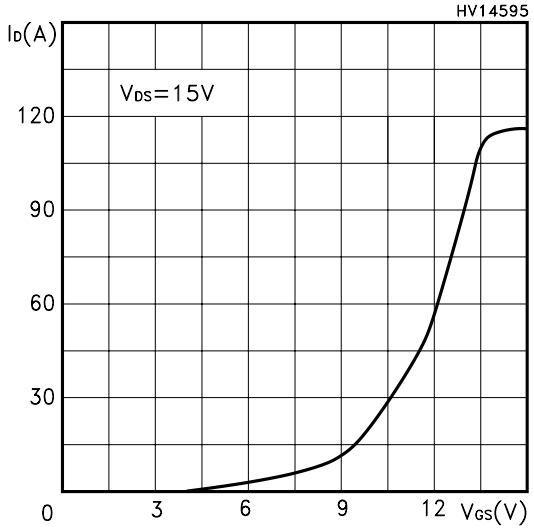
Switching Off Safe Operating Area



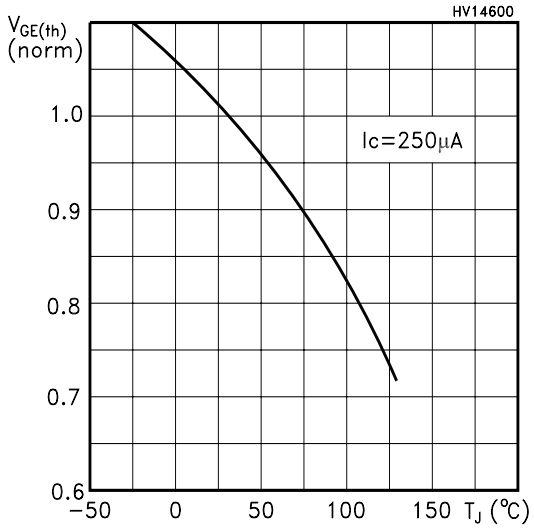
Output Characteristics



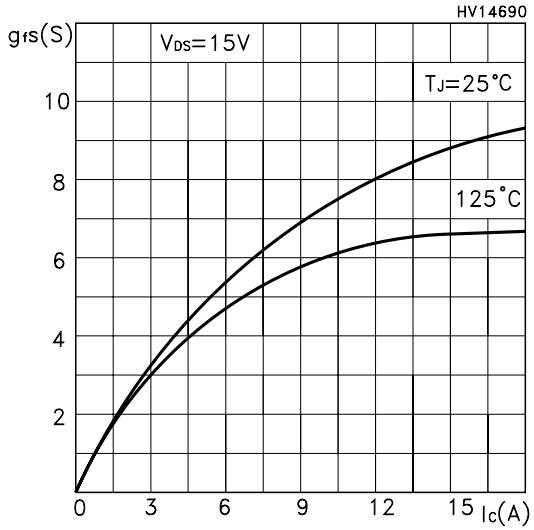
Transfer Characteristics



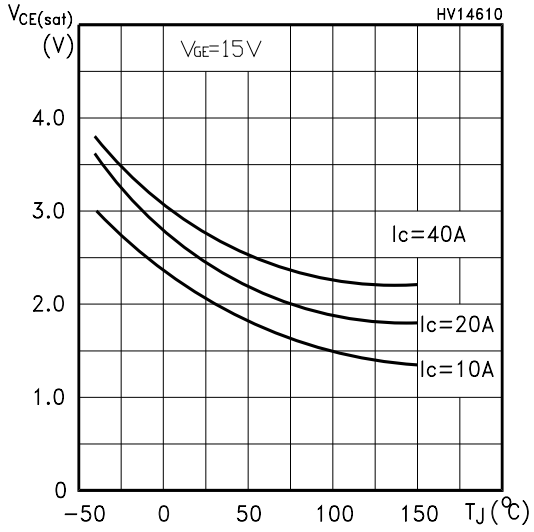
Normalized Gate Threshold Voltage vs Temp.



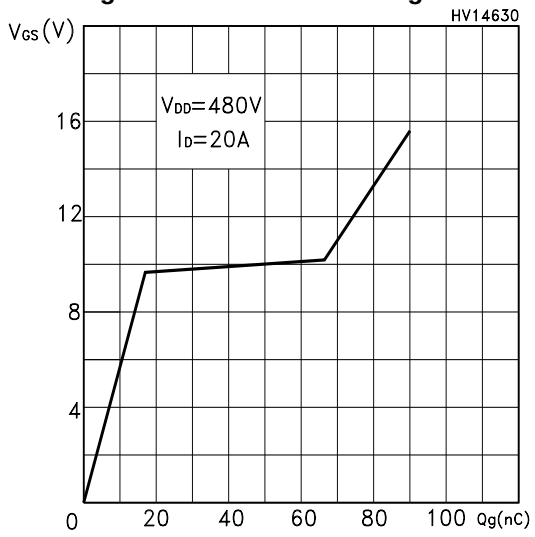
Transconductance



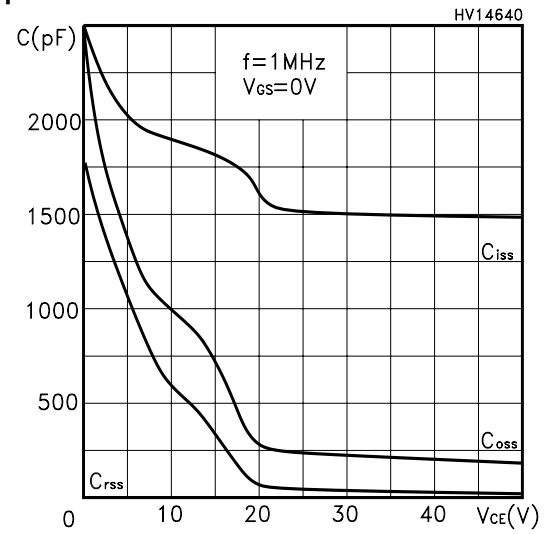
Collector-Emitter On Voltage vs Temperature



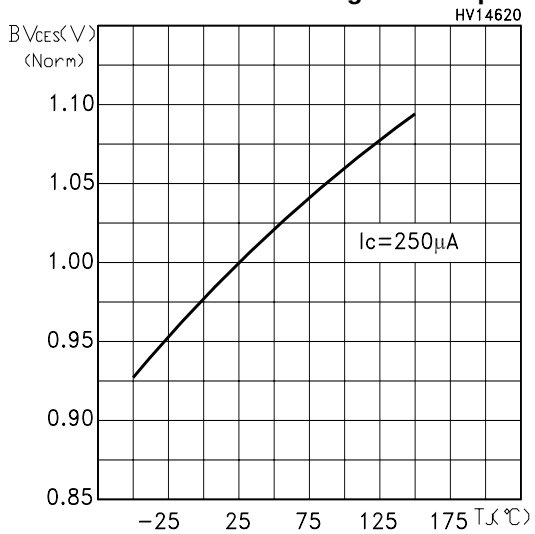
Gate-Charge vs Gate-Emitter Voltage



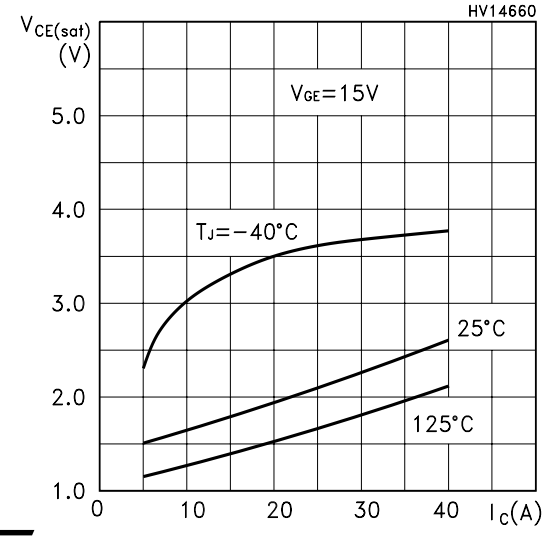
Capacitance Variations



Normalized Break-down Voltage vs Temp.



Collector-Emitter on Voltage vs Collector Current



Turn-Off Energy Losses vs Temperature

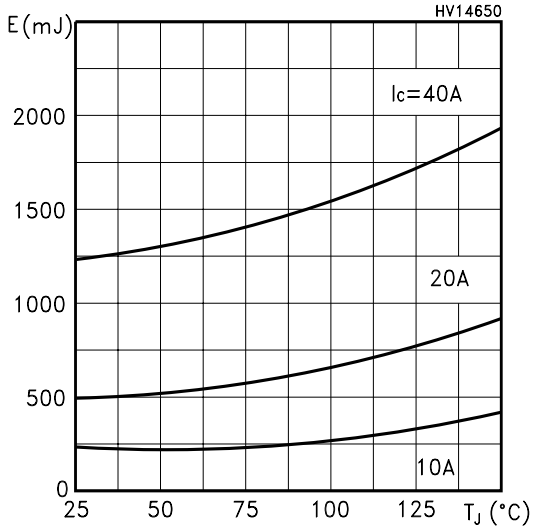


Fig. 1: Gate Charge test Circuit

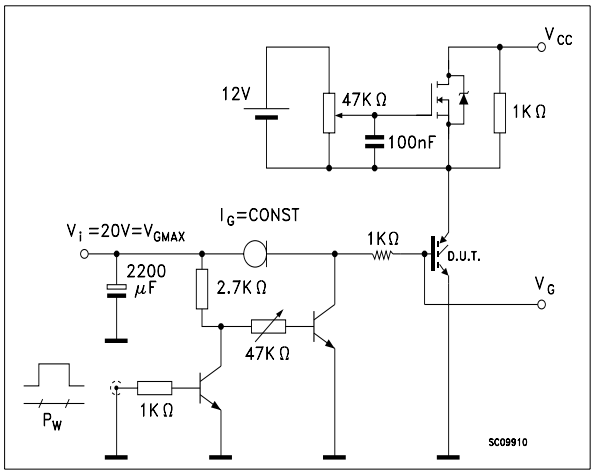
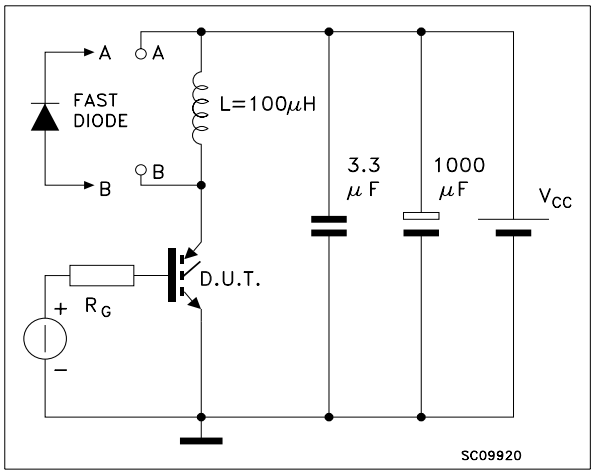
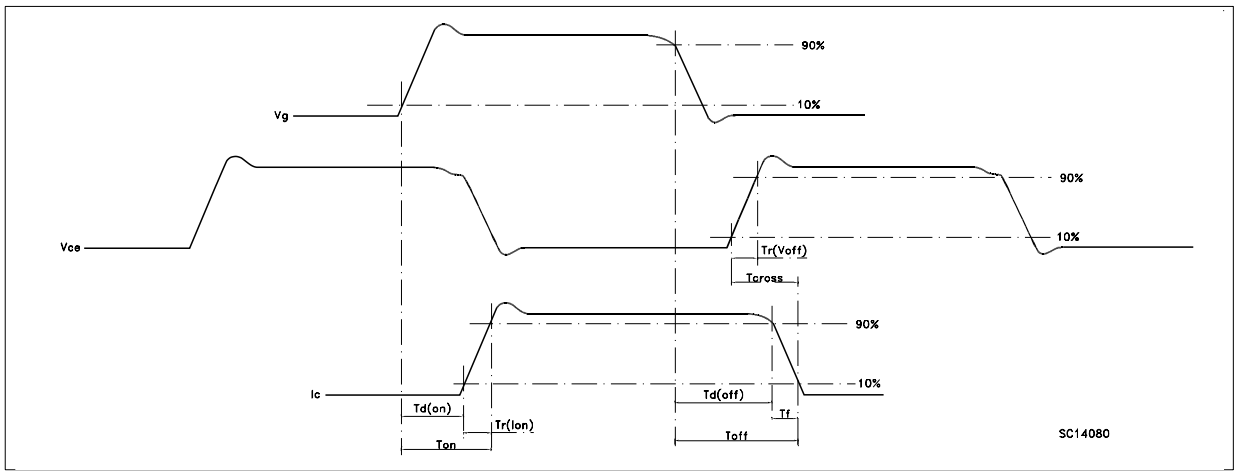


Fig. 2: Test Circuit For Inductive Load Switching





TO-247 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.85		5.15	0.19		0.20
D	2.20		2.60	0.08		0.10
E	0.40		0.80	0.015		0.03
F	1		1.40	0.04		0.05
F1		3			0.11	
F2		2			0.07	
F3	2		2.40	0.07		0.09
F4	3		3.40	0.11		0.13
G		10.90			0.43	
H	15.45		15.75	0.60		0.62
L	19.85		20.15	0.78		0.79
L1	3.70		4.30	0.14		0.17
L2		18.50			0.72	
L3	14.20		14.80	0.56		0.58
L4		34.60			1.36	
L5		5.50			0.21	
M	2		3	0.07		0.11
V		5º			5º	
V2		60º			60º	
Dia	3.55		3.65	0.14		0.143